High-speed electrical testing of		
multichip ceramic modules	Manzer	687
Verification		
Functional formal verification on		
designs of pSeries microprocessors	a	
and communication subsystems Functional verification of the POWER5	Gott	565
microprocessor and POWER5		
multiprocessor systems	Victor	541
Using microcode in the functional		
verification of an I/O chip	Goldman	581
Verification strategy for the Blue	XX7 1 1:	202
Gene/L chip	Wazlowski	303
Virtual machines		
Advanced virtualization capabilities of		
POWER5 systems	Armstrong	523
VLSI		
Microminiature packaging and		
integrated circuitry: The work of E. F.		
Rent, with an application to on-chip	T	
interconnection requirements	Lanzerotti	777

Errata

In the paper "Characterization of Simultaneous Multithreading (SMT) Efficiency in POWER5" by H. M. Mathis et al. in the *IBM Journal of Research and Development*, Volume 49, No. 4/5, July/September 2005, the last entry in the SMT gain column of Table 1 (p. 558) should represent a negative percentage, i.e., -11.2.

The names S. A. Cordes and J. L. Speidell were erroneously omitted from the author list of the paper entitled "Low-Cost Wafer Bumping" by P. A. Gruber, L. Bélanger, G. P. Brouillette, D. H. Danovitch, J.-L. Landreville, D. T. Naugle, V. A. Oberson, D.-Y. Shih, C. L. Tessler, and M. R. Turgeon in the *IBM Journal of Research and Development*, Volume 49, No. 4/5, July/September 2005. Their biographies follow.

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